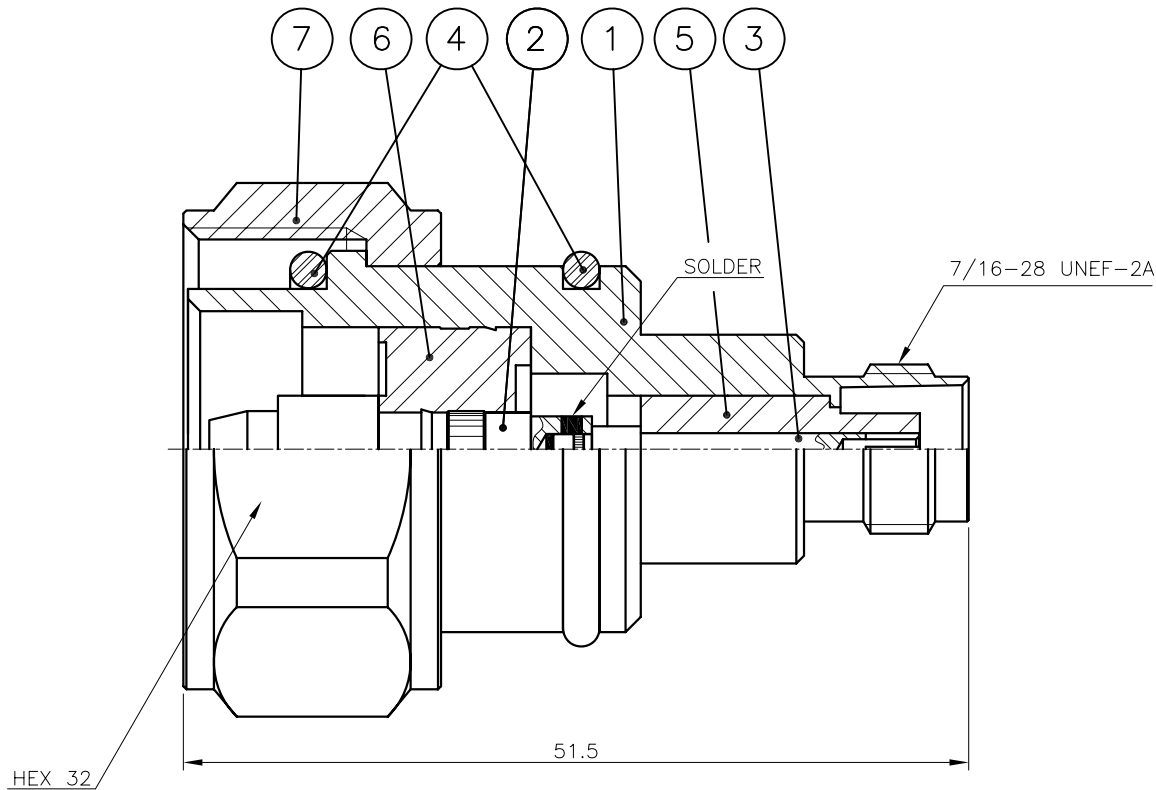


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2017.04.27.



*조립 방법

1. ②,③ PIN을 억지끼움 및 SOLDER 한다.
2. BODY에 ⑤,⑥TEFLON을 조립한다.
3. ⑤,⑥TEFLON이 조립된 BODY에 SOLDER된 PIN을 조립한다.
4. COUPLING CAP을 조립한다.
5. GASKET을 조립한다.

* 전기적 특성

1	Frequency range	DC ~ 3GHz	
2	Impedance	50Ω NOMINAL	
3	V.S.W.R	1.2 : 1 max	
4	Insertion Loss	-0.2dB min	
5	PIMD-DIN TERM (-43dBm / 2 tone)	CDMA WCDMA	3차 : -160dBc max

7	COUPLING CAP	1	MBsBD C3601BD-F	Nickel Plate	DCU00078-5/2 (K5015)
6	INSULATOR	1	TEFLON		DIN01680-N/1
5	INSULATOR	1	TEFLON		DIN02807-N/1
4	GASKET	2	SILICONE RUB		DGK00054-N/1 (G5006)
3	CONTACT	1	BeCu C17300	Silver (3μm)	DAC03276-5/1
2	CONTACT	1	MBsBD C3601BD-F	Silver (3μm)	DAC03275-5/1
1	BODY	1	MBsBD C3604BD-F	이원합금(Ni/Tin)	DAD00337-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2017. 04. 27.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL	-	CHECKED BY		KJ COMTECH CO.,LTD. TITLE 7/16 DIN(M)-TNC50(F) ADAPTOR
		DRAWN BY	S.Y.EUN	
FINISH	-	SCALE	2/1	A4 DWG NO. AD00609-7/1 REVISION I R SHEET 1 of 1
		UNIT	mm	